

### **PSE Technology Corporation**

### SPECIFICATION FOR APPROVAL

CUSTOMER	
NOMINAL FREQUENCY	26.000000 MHz
PRODUCT TYPE	TYPE FW 2.0x1.6 SEAM SEALED CRYSTAI
PART NUMBER	FW2600018
CUSTOMER P/N	
ISSUE DATE	July 13, 2012
VERSION	В

APPROVED	PREPARED	QA
Brenda	Niklai Lu	Bedryeri
	APPROVED BY CUSTOMER	

Please return one copy with approval to PSE-TW

#### **PSE Technology Corporation**

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- \*Pb-free
- \*RoHS Compliant
- \*HF-Halogen Free
- \*REACH Compliant

A Company of PERICOM Semiconductor Corporation

E0-R-4-014 Rev.E

VER.B 12-JUL-12

#### **VERSION HISTORY**

Version No.	Version Date	Customer Receipt Date	Supplier Receipt Date	Description	Notes
А	Apr. 6, 2011			Initial Release	
В	Jul. 12, 2012			Changed tolerance in mechanical drawing & Added Maximum Drive Level 150uW	

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#### **ELECTRICAL SPECIFICATIONS**

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	26.000000	MHz	
Mode of Oscillation	МО	AT Cut-Fundamental		
Calibration Load Capacitance	CL	9	pF	
Calibration Tolerance	FL	± 10	ppm	at 25°C±3°C
Operating Temperature Range	TR	-20 to +75	°C	
Frequency Stability(Frequency Deviation over the Operating Temperature Range)	F/T	± 10	ppm	Reference to the Frequency at 25°C
Operating Drive Level		100	μW	
Maximum Drive Level		150	μW	
Equivalent Series Resistance	ESR	60	Ω	Max.
Shunt Capacitance	C0	0.7	pF	Тур.
Motional Capacitance	C1	1.8	fF	Тур.
C0/C1 Ratio	C0/C1	390		Тур.
Aging at 25°C		± 1	ppm	Max, 1st year
Storage Temperature		-55 to +125	°C	
Insulation Resistance		500	ΜΩ	Min

<sup>\*\*</sup> This product doesn"t include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).

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#### RELIABILITY SPECIFICATIONS

MECHANICAL AND ENVIRONMENTAL RATINGS:

a)FINE LEAK TEST: JESD22-A109 (Condition 1A)

b)GROSS LEAK TEST: JESD22-A109 (Condition C)

c)MOISTURE RESISTANCE: JESD22-A113

d)SHOCK: JESD22-B104 (Condition B)

e)SOLDERABILITY: (RoHS version): J-STD-002

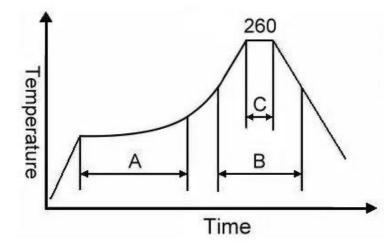
f)VIBRATION: JESD22-B103

g)SOLVENT RESISTANCE: JESD22-B107

h)RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

#### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D



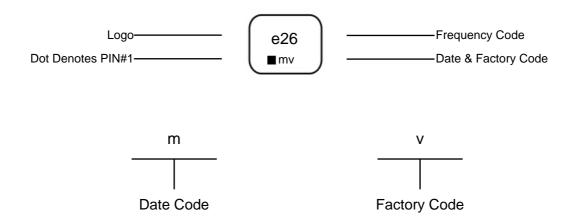
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	Stage	Temperature	Time
Α	Preheat	150~200°C	60~120 Sec
В	Primary Heat	217°C	60~150 Sec
С	Peak	260°C	10 Sec

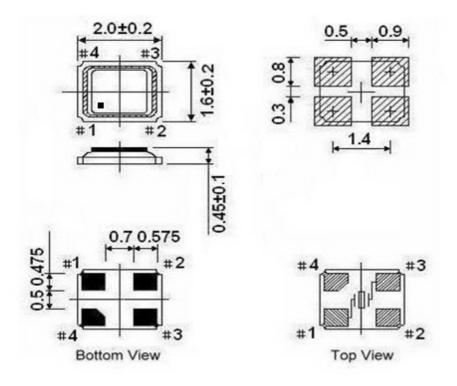
For soldering reflow profile and reliability test ratings go to: http://www.pericom.com/pdf/sre/reflow.pdf

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#### **MARKING**



#### MECHANICAL DRAWINGS (Scale: None. Dimensions are in mm.)



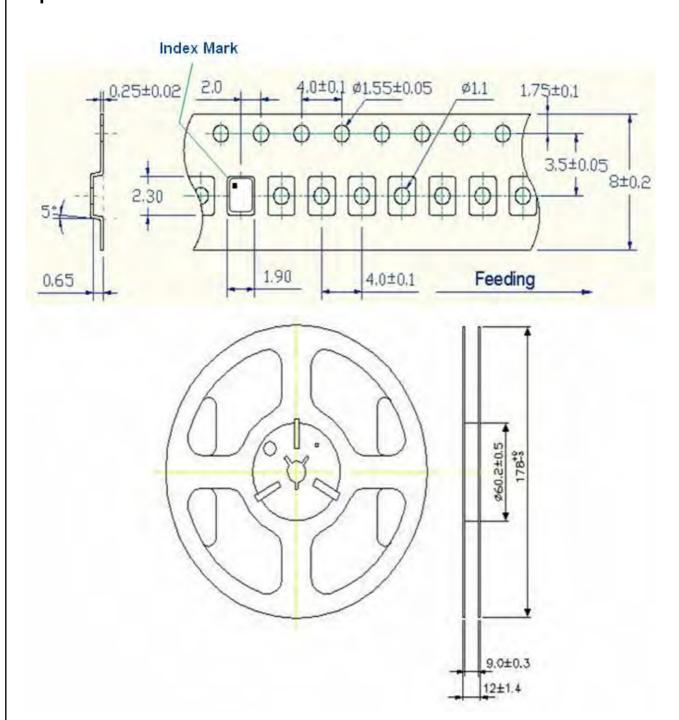
\*\* Recommended - Pin 1 & 3 : CRYSTAL Pin 2 & 4 : GND

#### Note:

- 1. The marking dot denotes Pin#1.
- Pin positions of the drawing is only for reference, and the Pin with chamfer is based on the real product.

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#### Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.

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